



# TDA7564B

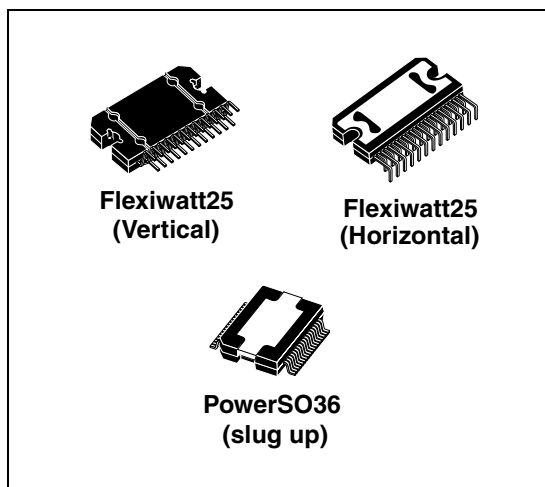
4 x 50W multifunction quad power amplifier  
with built-in diagnostics feature

## Features

- Multipower BCD technology
- MOSFET output power stage
- DMOS power output
- New high efficiency (class SB)
- High output power capability 4x28 W/4  $\Omega$  @ 14.4 V, 1 kHz, 10 % THD, 4x50 W max, power
- Max. output power 4x72 W/2  $\Omega$
- Full I<sup>2</sup>C bus driving:
  - Standby
  - Independent front/rear soft play/mute
  - Selectable gain (for low noise line output function)
  - High efficiency enable/disable
  - I<sup>2</sup>C bus digital diagnostics (including AC and DC load detection)
- Full fault protection
- DC offset detection
- Four independent short circuit protection
- Clipping detector (2 %/10 %)
- Linear thermal shutdown with multiple thermal warning
- ESD protection

## Description

The TDA7564B is a new BCD technology quad bridge type of car radio amplifier in Flexiwatt25 /



PowerSO36 package specially intended for car radio applications.

Thanks to the DMOS output stage the TDA7564B has a very low distortion allowing a clear powerful sound. Among the features, its superior efficiency performance coming from the internal exclusive structure, makes it the most suitable device to simplify the thermal management in high power sets.

The dissipated output power under average listening condition is in fact reduced up to 50% when compared to the level provided by conventional class AB solutions. This device is equipped with a full diagnostics array that communicates the status of each speaker through the I<sup>2</sup>C bus.

**Table 1. Device summary**

Order code	Package	Packing
TDA7564B	Flexiwatt25 (vertical)	Tube
TDA7564BH	Flexiwatt25 (horizontal)	Tube
TDA7564BPD	PowerSO36	Tube
TDA7564BPDTR	PowerSO36	Tape and reel

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# 1 Block diagrams and application circuit

Figure 1. Block diagram

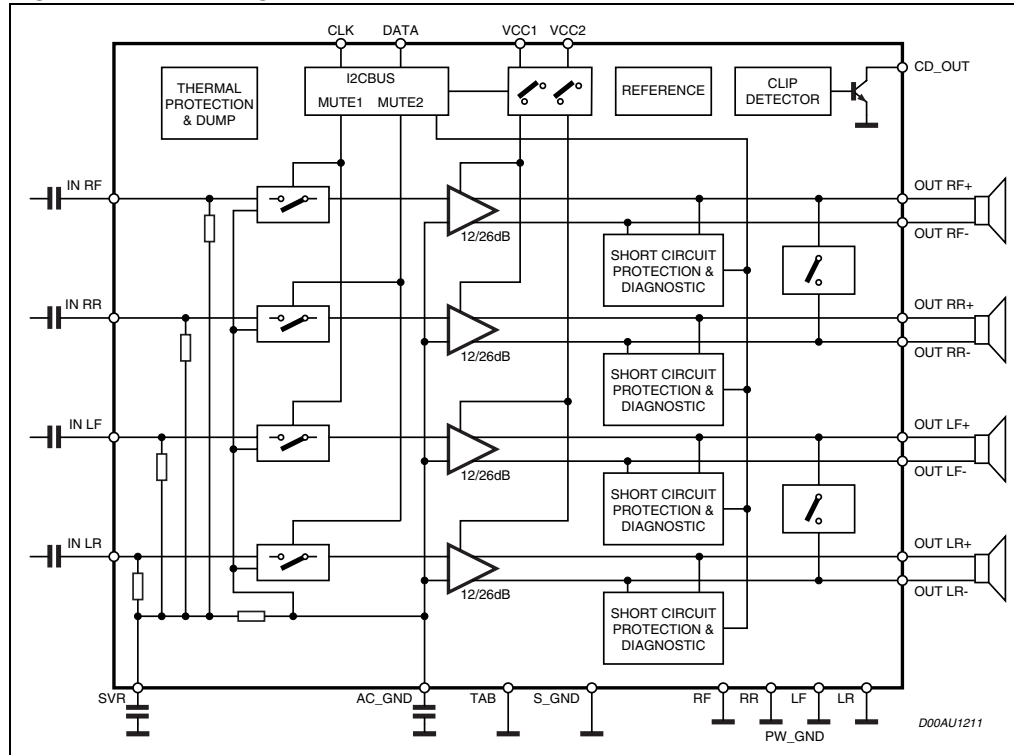
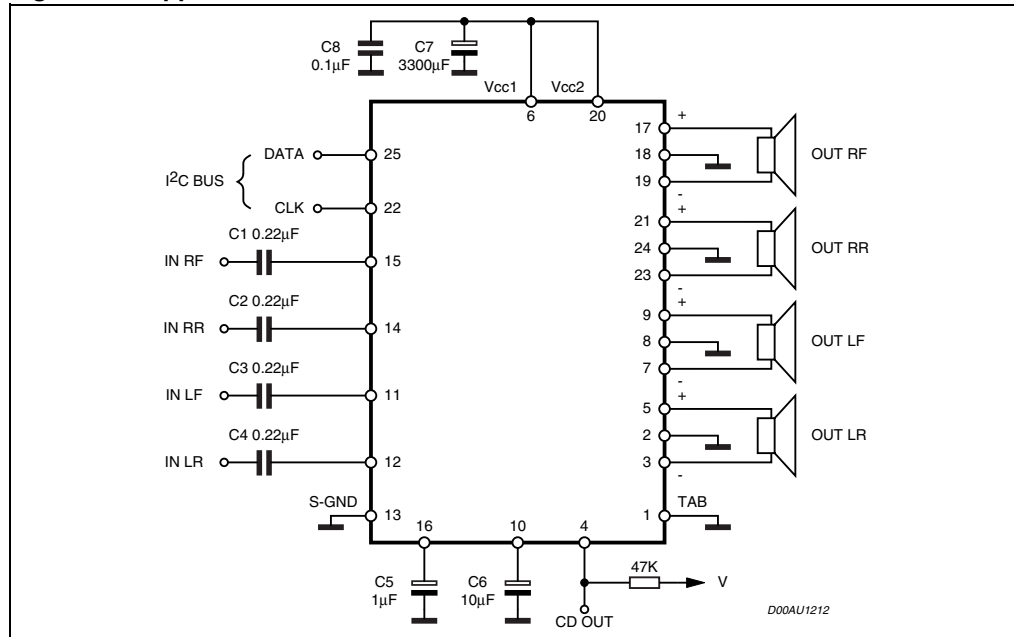


Figure 2. Application circuit



2 Pins description

Figure 3. Flexiwatt25 pins connection diagram (top of view)

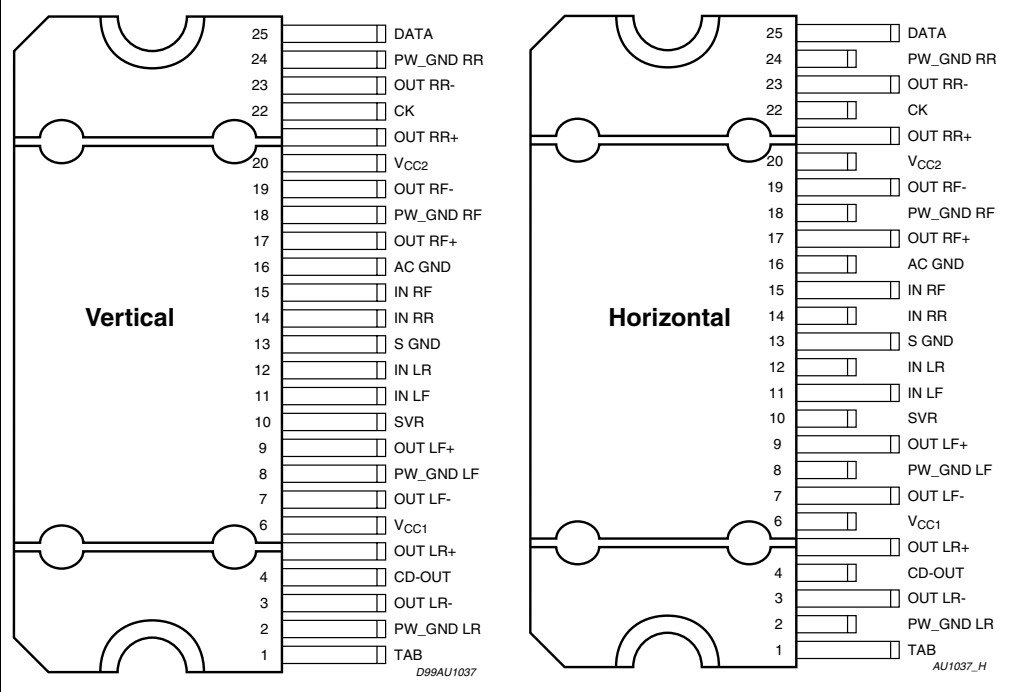
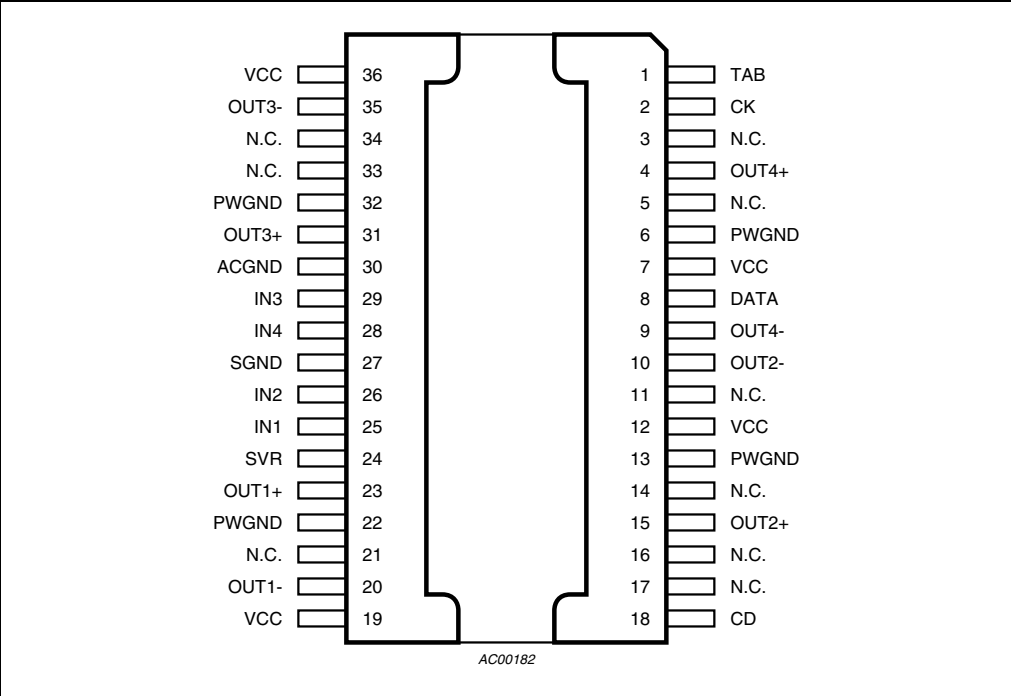


Figure 4. PowerSO36 (slug-up) pins connection diagram (top of view)



### 3 Electrical specifications

#### 3.1 Absolute maximum ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{op}$	Operating supply voltage	18	V
$V_S$	DC supply voltage	28	V
$V_{peak}$	Peak supply voltage (for $t = 50$ ms)	50	V
$V_{CK}$	CK pin voltage	6	V
$V_{DATA}$	Data pin voltage	6	V
$I_O$	Output peak current (not repetitive $t = 100$ ms)	8	A
$I_O$	Output peak current (repetitive $f > 10$ Hz)	6	A
$P_{tot}$	Power dissipation $T_{case} = 70$ °C	85	W
$T_{stg}, T_j$	Storage and junction temperature	-55 to 150	°C

#### 3.2 Thermal data

**Table 3. Thermal data**

Symbol	Parameter	PowerSO	Flexiwatt	Unit
$R_{th\ j-case}$	Thermal resistance junction-to-case	Max. 1	1	°C/W

#### 3.3 Electrical characteristics

Refer to the test circuit,  $V_S = 14.4$  V;  $R_L = 4$   $\Omega$ ;  $f = 1$  kHz;  $G_V = 30$  dB;  $T_{amb} = 25$  °C; unless otherwise specified.

**Table 4. Electrical characteristics**

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
<b>Power amplifier</b>						
$V_S$	Supply voltage range	-	8	-	18	V
$I_d$	Total quiescent drain current	-	-	170	300	mA
$P_O$	Output power	Max. power ( $V_S = 15.2$ V, square wave input (2 $V_{rms}$ ))	-	50	-	W
		THD = 10 %	25	28	-	W
		THD = 1 %	20	22	-	W



Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$P_O$	Output power	$R_L = 2 \Omega$ ; EIAJ ( $V_S = 13.7V$ ) $R_L = 2 \Omega$ ; THD 10% $R_L = 2 \Omega$ ; THD 1% $R_L = 2 \Omega$ ; max. power	55 40 32 60	68 50 40 75	-	W
THD	Total harmonic distortion	$P_O = 1 W$ to $10 W$ ; STD mode HE MODE; $P_O = 1.5 W$ HE MODE; $P_O = 8 W$	-	0.02 0.015 0.15	0.1 0.1 0.5	%
		$G_V = 12 dB$ ; STD mode $V_O = 0.1$ to $5 V_{RMS}$	-	0.02	0.05	%
$C_T$	Cross talk	$f = 1 kHz$ to $10 kHz$ , $R_g = 600 \Omega$	50	60	-	dB
$R_{IN}$	Input impedance	-	60	100	130	$k\Omega$
$G_{V1}$	Voltage gain 1	-	25	26	27	dB
$\Delta G_{V1}$	Voltage gain match 1	-	-1	-	1	dB
$G_{V2}$	Voltage gain 2	-	11	12	13	dB
$\Delta G_{V2}$	Voltage gain match 2	-	-1	-	1	dB
$E_{IN1}$	Output noise voltage 1	$R_g = 600 \Omega$ 20 Hz to 22 kHz	-	35	100	$\mu V$
$E_{IN2}$	Output noise voltage 2	$R_g = 600 \Omega$ ; $G_V = 12 dB$ 20 Hz to 22 kHz	-	12	30	$\mu V$
SVR	Supply Voltage Rejection	$f = 100 Hz$ to $10 kHz$ ; $V_r = 1 V_{pk}$ ; $R_g = 600 \Omega$	50	60	-	dB
BW	Power bandwidth	-	100	-	-	kHz
$A_{SB}$	Standby attenuation	-	90	110	-	dB
$I_{SB}$	Standby current	$V_{st-by} = 0$	-	25	50	$\mu A$
$A_M$	Mute attenuation	-	80	100	-	dB
$V_{OS}$	Offset voltage	Mute and play	-100	0	100	mV
$V_{AM}$	Min. supply mute threshold	-	6.5	7	8	V
CMRR	Input CMRR	$V_{CM} = 1 V_{pk-pk}$ ; $R_g = 0 \Omega$	-	55	-	dB
$T_{ON}$	Turn ON Delay	D2/D1 (IB1) 0 to 1	-	20	40	ms
$T_{OFF}$	Turn OFF Delay	D2/D1 (IB1) 1 to 0	-	20	40	ms
$CD_{LK}$	Clip det high leakage current	CD off	-	0	5	$\mu A$
$CD_{SAT}$	Clip det sat. voltage	CD on; $I_{CD} = 1 mA$	-	150	300	mV
$CD_{THD}$	Clip det THD level	D0 (IB1) = 1	5	10	15	%
		D0 (IB1) = 0	1	2	3	%

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
Turn on diagnostics 1 (Power amplifier mode)						
Pgnd	Short to GND det. (below this limit, the output is considered in short circuit to GND)	Power amplifier in standby	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to VS)		Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (Within these limits, the output is considered without faults).		1.8	-	Vs -1.8	V
Lsc	Shorted load det.		-	-	0.5	Ω
Lop	Open load det.		85	-	-	Ω
Lnop	Normal load det.		1.5	-	45	Ω
Turn on diagnostics 2 (Line driver mode)						
Pgnd	Short to GND det. (below this limit, the output is considered in short circuit to GND)	Power amplifier in standby	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to VS)	-	Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (Within these limits, the output is considered without faults).	-	1.8	-	Vs -1.8	V
Lsc	Shorted load det.	-	-	-	2	Ω
Lop	Open load det.	-	330	-	-	Ω
Lnop	Normal load det.	-	7	-	180	Ω
Permanent diagnostics 2 (Power amplifier mode or line driver mode)						
Pgnd	Short to GND det. (below this limit, the output is considered in short circuit to GND)	Power amplifier in mute or play, one or more short circuits protection activated	-	-	1.2	V
Pvs	Short to Vs det. (above this limit, the output is considered in short circuit to VS)		Vs -1.2	-	-	V
Pnop	Normal operation thresholds. (within these limits, the output is considered without faults).		1.8	-	Vs -1.8	V
LSC	Shorted load det.	Pow. amp. mode	-	-	0.5	Ω
		Line driver mode	-	-	2	Ω
VO	Offset detection	Power amplifier in play, AC Input signals = 0	±1.5	±2	±2.5	V
INLH	Normal load current detection	VO < (VS - 5)pk IB2 (D7) = 0	500	-	-	mA

Table 4. Electrical characteristics (continued)

Symbol	Parameter	Test condition	Min.	Typ.	Max.	Unit
$I_{NLL}$	Normal load current detection	$V_O < (V_S - 5)\text{pk IB2 (D7)} = 1$	250	-		mA
$I_{OLH}$	Open load current detection	$V_O < (V_S - 5)\text{pk IB2 (D7)} = 0$	-	-	250	mA
$I_{OLL}$	Open load current detection	$V_O < (V_S - 5)\text{pk IB2 (D7)} = 1$	-	-	125	mA
<b>I<sup>2</sup>C bus interface</b>						
$S_{CL}$	Clock frequency	-	-	-	400	kHz
$V_{IL}$	Input low voltage	-	-	-	1.5	V
$V_{IH}$	Input high voltage	-	2.3	-	-	V

### 3.4 Electrical characteristics curves

Figure 5. Quiescent current vs. supply voltage

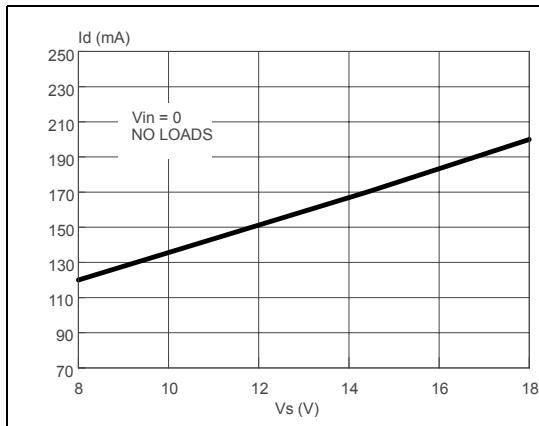


Figure 6. Output power vs. supply voltage (4 Ω)

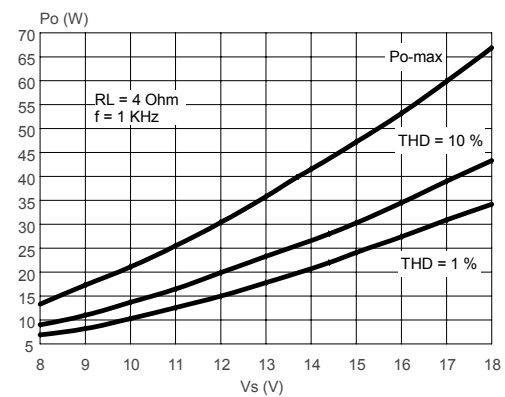


Figure 7. Output power vs. supply voltage (2 Ω)

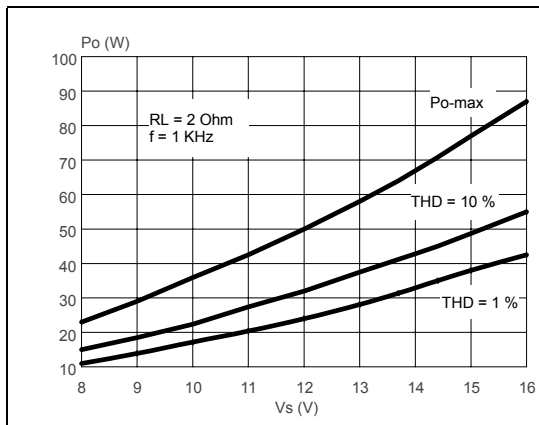
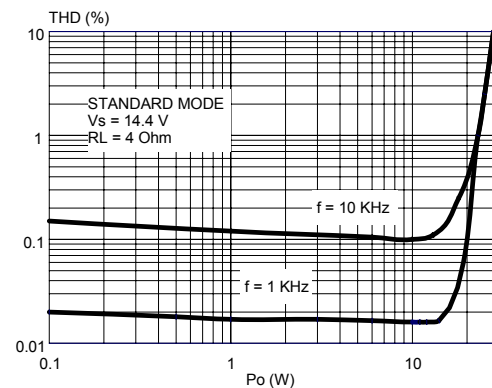
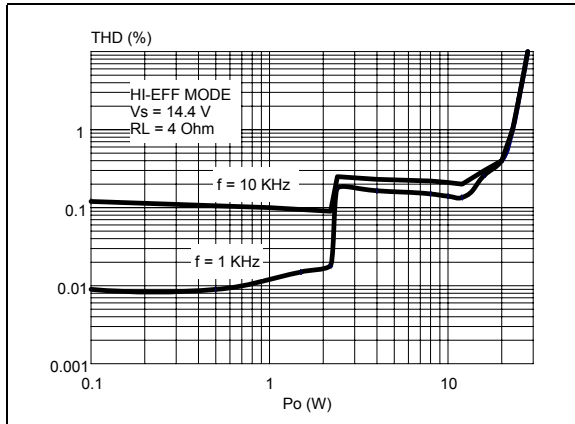


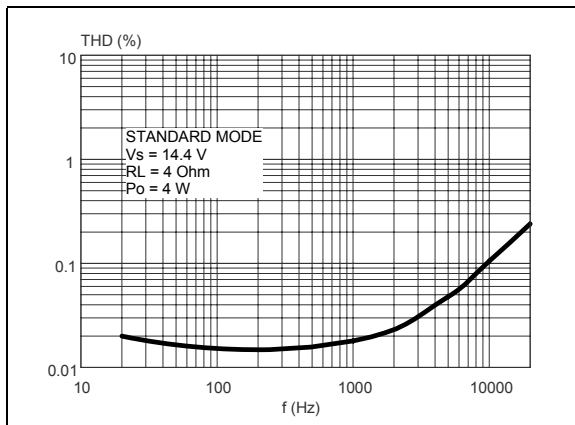
Figure 8. Distortion vs. output power (4 Ω, STD)



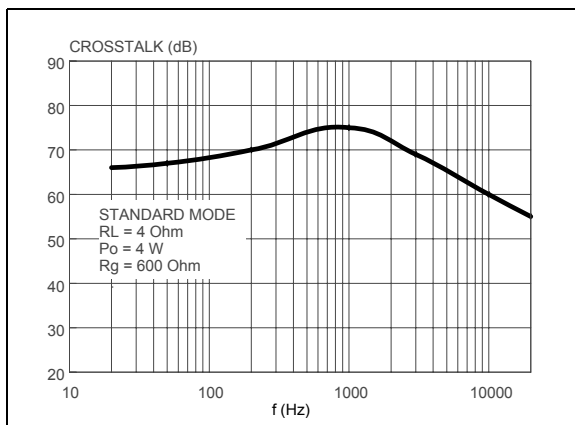
**Figure 9. Distortion vs. output power (4  $\Omega$ , HI-EFF)**



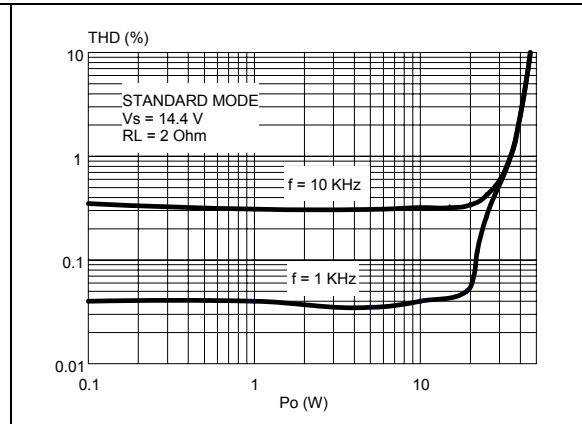
**Figure 11. Distortion vs. frequency (4  $\Omega$ )**



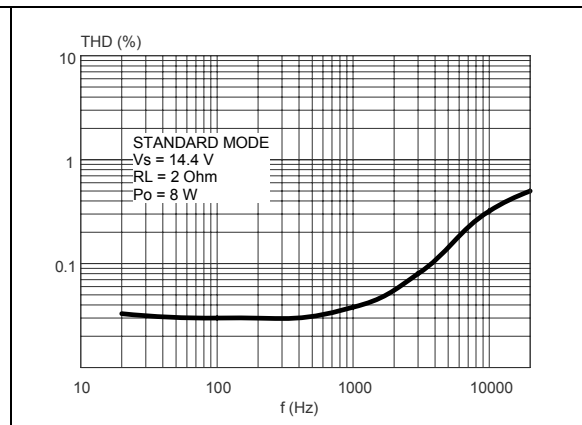
**Figure 13. Crosstalk vs. frequency**



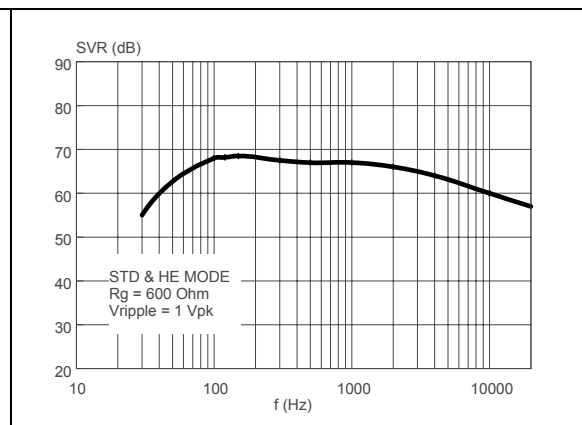
**Figure 10. Distortion vs. output power (2  $\Omega$ , STD)**



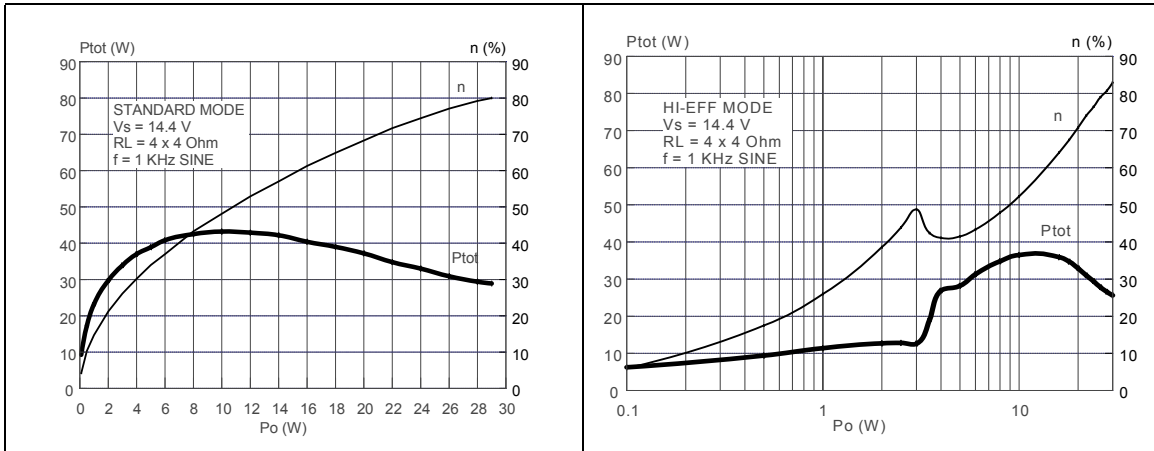
**Figure 12. Distortion vs. frequency (2  $\Omega$ )**



**Figure 14. Supply voltage rejection vs. freq.**

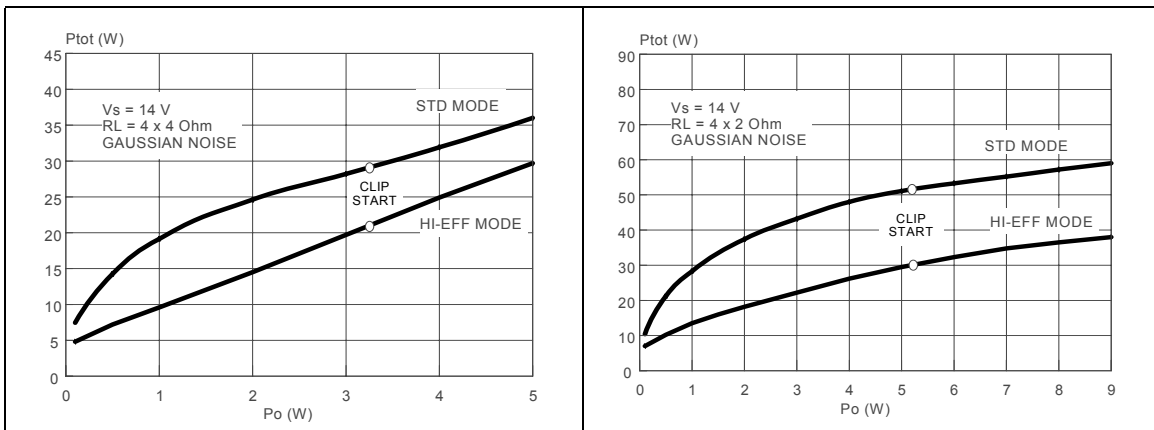


**Figure 15. Power dissipation and efficiency vs. output power (4  $\Omega$ , STD, SINE)** **Figure 16. Power dissipation and efficiency vs. output power (4  $\Omega$ , Hi-eff, SINE)**



**Figure 17. Power dissipation vs. average output power (audio program simulation, 4  $\Omega$ )**

**Figure 18. Power dissipation vs. average output power (audio program simulation, 2  $\Omega$ )**



## 4 Diagnostics functional description

### 4.1 Turn-on diagnostic

It is activated at the turn-on (standby out) under I<sup>2</sup>C bus request. Detectable output faults are:

- Short to GND
- Short to Vs
- Short across the speaker
- Open speaker

To verify if any of the above misconnections are in place, a subsonic (inaudible) current pulse (Figure 19) is internally generated, sent through the speaker(s) and sunk back. The Turn-on diagnostic status is internally stored until a successive diagnostic pulse is requested (after a I<sup>2</sup>C reading).

If the "standby out" and "diag. enable" commands are both given through a single programming step, the pulse takes place first (power stage still in standby mode, low, outputs = high impedance).

Afterwards, when the amplifier is biased, the permanent diagnostic takes place. The previous turn-on state is kept until a short appears at the outputs.

**Figure 19. Turn - on diagnostic: working principle**

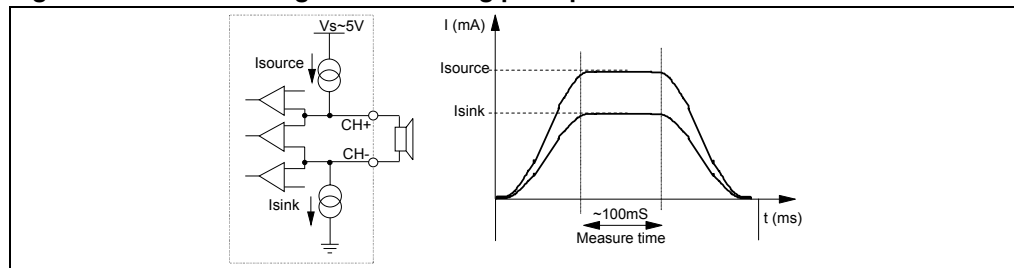


Figure 20 and 21 show SVR and output waveforms at the turn-on (standby out) with and without turn-on diagnostic.

**Figure 20. SVR and output behavior (case 1: without turn-on diagnostic)**

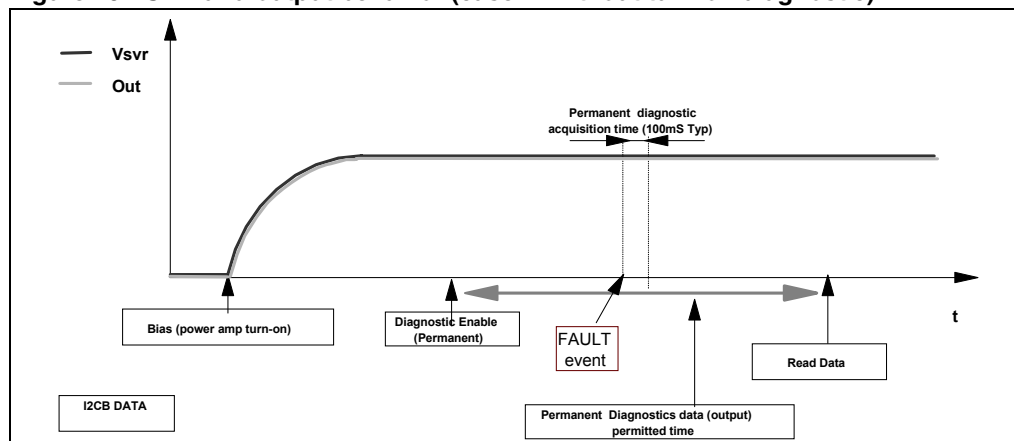
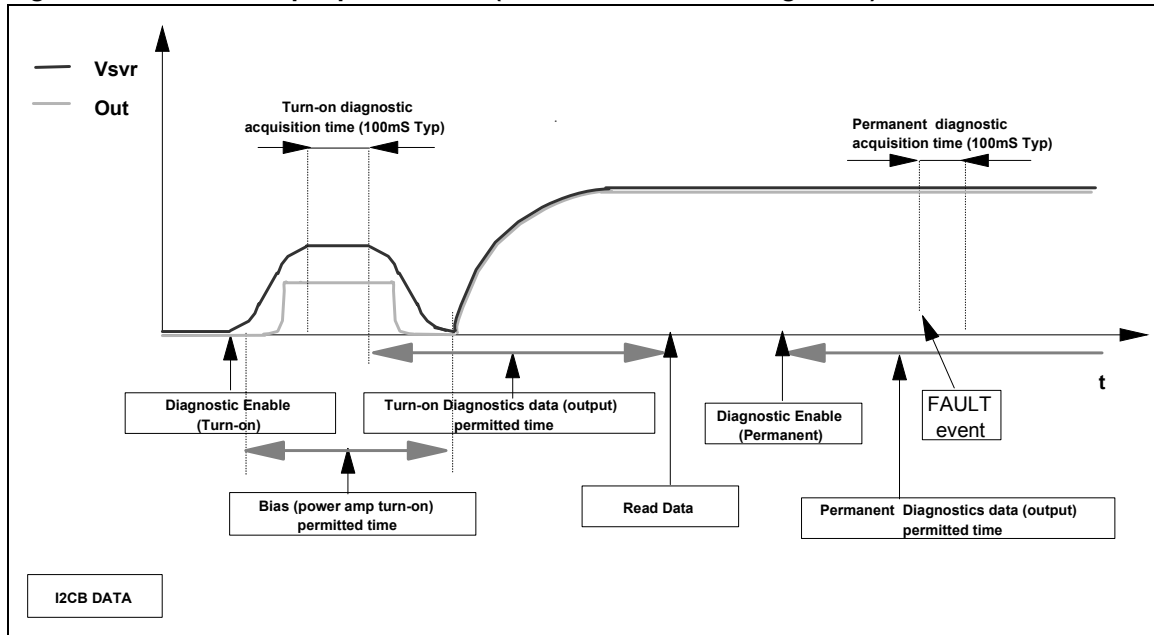
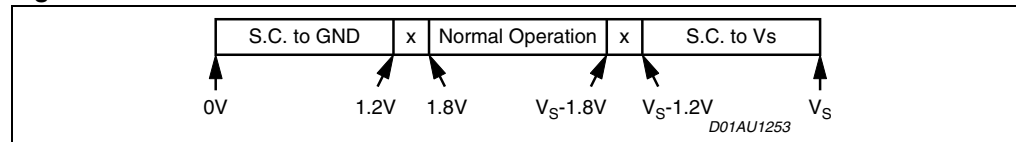


Figure 21. SVR and output pin behavior (case 2: with turn-on diagnostic)



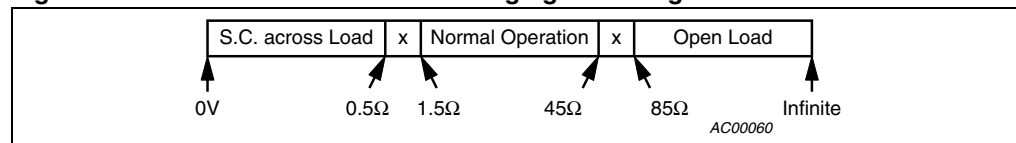
The information related to the outputs status is read and memorized at the end of the current pulse top. The acquisition time is 100 ms (typ.). No audible noise is generated in the process. As for short to GND / Vs the fault-detection thresholds remain unchanged from 26 dB to 12 dB gain setting. They are as follows:

Figure 22. Short circuit detection thresholds



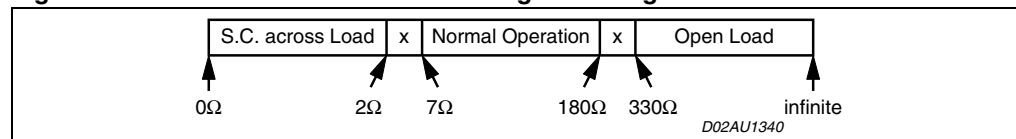
Concerning short across the speaker / open speaker, the threshold varies from 26 dB to 12 dB gain setting, since different loads are expected (either normal speaker's impedance or high impedance). The values in case of 26 dB gain are as follows:

Figure 23. Load detection thresholds - high gain setting



If the line-driver mode ( $G_v = 12$  dB and Line Driver Mode diagnostic = 1) is selected, the same thresholds will change as follows:

Figure 24. Load detection threshold - low gain setting



## 4.2 Permanent diagnostics

Detectable conventional faults are:

- Short to GND
- Short to  $V_S$
- Short across the speaker

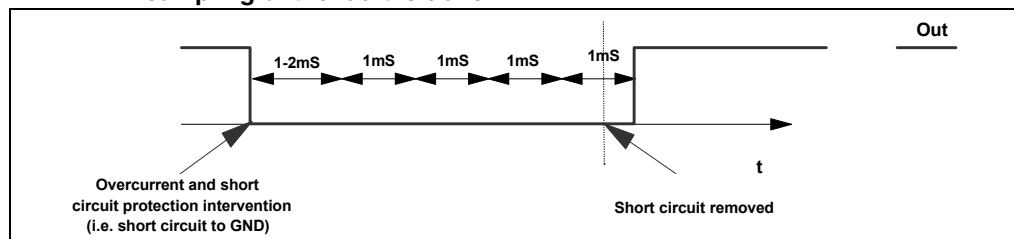
The following additional features are provided:

- Output offset detection

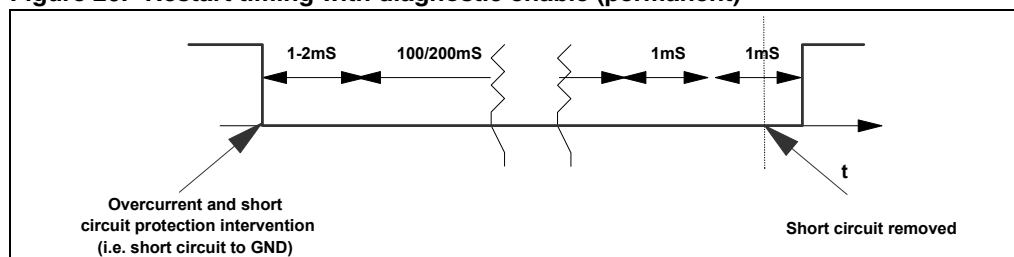
The TDA7564B has 2 operating statuses:

1. **Restart mode.** The diagnostic is not enabled. Each audio channel operates independently from each other. If any of the a.m. faults occurs, only the channel(s) interested is shut down. A check of the output status is made every 1 ms (*Figure 25*). Restart takes place when the overload is removed.
2. **Diagnostic mode.** It is enabled via I<sup>2</sup>C bus and self activates if an output overload (such to cause the intervention of the short-circuit protection) occurs to the speakers outputs. Once activated, the diagnostics procedure develops as follows (*Figure 26*):
  - To avoid momentary re-circulation spikes from giving erroneous diagnostics, a check of the output status is made after 1ms: if normal situation (no overloads) is detected, the diagnostic is not performed and the channel returns back active.
  - Instead, if an overload is detected during the check after 1 ms, then a diagnostic cycle having a duration of about 100 ms is started.
  - After a diagnostic cycle, the audio channel interested by the fault is switched to restart mode. The relevant data are stored inside the device and can be read by the microprocessor. When one cycle has terminated, the next one is activated by an I<sup>2</sup>C reading. This is to ensure continuous diagnostics throughout the car-radio operating time.
  - To check the status of the device a sampling system is needed. The timing is chosen at microprocessor level (over half a second is recommended).

**Figure 25. Restart timing without diagnostic enable (permanent) - Each 1mS time, a sampling of the fault is done**



**Figure 26. Restart timing with diagnostic enable (permanent)**





### 4.3 Output DC offset detection

Any DC output offset exceeding  $\pm 2$  V are signalled out. This inconvenient might occur as a consequence of initially defective or aged and worn-out input capacitors feeding a DC component to the inputs, so putting the speakers at risk of overheating.

This diagnostic has to be performed with low-level output AC signal (or  $V_{in} = 0$ ).

The test is run with selectable time duration by microprocessor (from a "start" to a "stop" command):

- Start = Last reading operation or setting IB1 - D5 - (offset enable) to 1
- Stop = Actual reading operation

Excess offset is signalled out if persistent throughout the assigned testing time. This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

### 4.4 AC diagnostic

It is targeted at detecting accidental disconnection of tweeters in 2-way speaker and, more in general, presence of capacitive (AC) coupled loads.

This diagnostic is based on the notion that the overall speaker's impedance (woofer + parallel tweeter) will tend to increase towards high frequencies if the tweeter gets disconnected, because the remaining speaker (woofer) would be out of its operating range (high impedance). The diagnostic decision is made according to peak output current thresholds, and it is enabled by setting (IB2-D2) = 1. Two different detection levels are available:

- High current threshold IB2 (D7) = 0  
 $I_{out} > 500$  mApk = normal status  
 $I_{out} < 250$  mApk = open tweeter
- Low current threshold IB2 (D7) = 1  
 $I_{out} > 250$  mApk = normal status  
 $I_{out} < 125$  mApk = open tweeter

To correctly implement this feature, it is necessary to briefly provide a signal tone (with the amplifier in "play") whose frequency and magnitude are such to determine an output current higher than 500 mApk with IB2(D7)=0 (higher than 250mApk with IB2(D7)=1) in normal conditions and lower than 250 mApk with IB2(D7)=0 (lower than 125 mApk with IB2(D7)=1) should the parallel tweeter be missing.

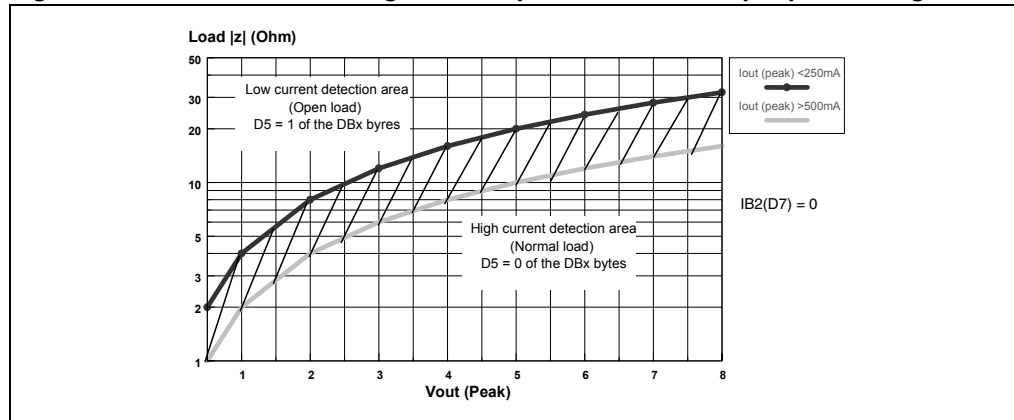
The test has to last for a minimum number of 3 sine cycles starting from the activation of the AC diagnostic function IB2<D2>) up to the I<sup>2</sup>C reading of the results (measuring period). To confirm presence of tweeter, it is necessary to find at least 3 current pulses over the above threshold over all the measuring period, else an "open tweeter" message will be issued.

The frequency / magnitude setting of the test tone depends on the impedance characteristics of each specific speaker being used, with or without the tweeter connected (to be calculated case by case). High-frequency tones (> 10 kHz) or even ultrasonic signals are recommended for their negligible acoustic impact and also to maximize the impedance module's ratio between with tweeter-on and tweeter-off.

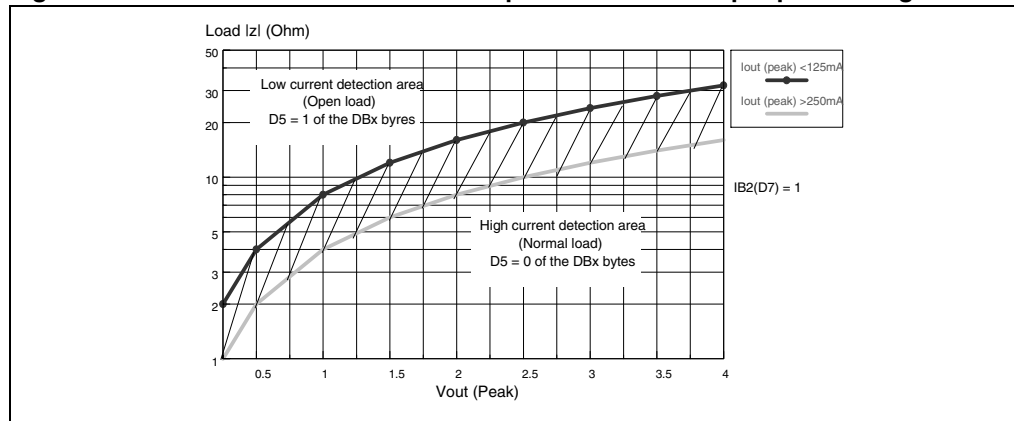
*Figure 27* shows the load impedance as a function of the peak output voltage and the relevant diagnostic fields.

This feature is disabled if any overloads leading to activation of the short-circuit protection occurs in the process.

**Figure 27. Current detection high: load impedance  $|Z|$  vs. output peak voltage**



**Figure 28. Current detection low: load impedance  $|Z|$  vs. output peak voltage**



## 5 Multiple faults

When more misconnections are simultaneously in place at the audio outputs, it is guaranteed that at least one of them is initially read out. The others are notified after successive cycles of I<sup>2</sup>C reading and faults removal, provided that the diagnostic is enabled. This is true for both kinds of diagnostic (turn-on and permanent).

The table below shows all the couples of double-fault possible. It should be taken into account that a short circuit with the 4 ohm speaker unconnected is considered as double fault.

**Table 5. Double fault table for turn-on diagnostic**

	S. GND (so)	S. GND (sk)	S. Vs	S. Across L.	Open L.
S. GND (so)	S. GND	S. GND	S. Vs + S. GND	S. GND	S. GND
S. GND (sk)	/	S. GND	S. Vs	S. GND	Open L. (*)
S. Vs	/	/	S. Vs	S. Vs	S. Vs
S. Across L.	/	/	/	S. Across L.	N.A.
Open L.	/	/	/	/	Open L. (*)

S. GND (so) / S. GND (sk) in the above table make a distinction according to which of the 2 outputs is shorted to ground (test-current source side= so, test-current sink side = sk). More precisely, in Channels LF and RR, so = CH+, sk = CH-; in Channels LR and RF, so = CH-, sk = CH+.

In permanent diagnostic the table is the same, with only a difference concerning open load (\*), which is not among the recognizable faults. Should an Open Load be present during the device's normal working, it would be detected at a subsequent Turn on Diagnostic cycle (i.e. at the successive car radio turn-on).

### 5.1 Faults availability

All the results coming from I<sup>2</sup>C bus, by read operations, are the consequence of measurements inside a defined period of time. If the fault is stable throughout the whole period, it will be sent out.

To guarantee always resident functions, every kind of diagnostic cycles (turn-on, permanent, offset) will be reactivate after any I<sup>2</sup>C reading operation. So, when the micro reads the I<sup>2</sup>C, a new cycle will be able to start, but the read data will come from the previous diag. cycle (i.e. The device is in turn-on state, with a short to GND, then the short is removed and micro reads I<sup>2</sup>C. The short to GND is still present in bytes, because it is the result of the previous cycle. If another I<sup>2</sup>C reading operation occurs, the bytes do not show the short). In general to observe a change in diagnostic bytes, two I<sup>2</sup>C reading operations are necessary.

## 6 Thermal protection

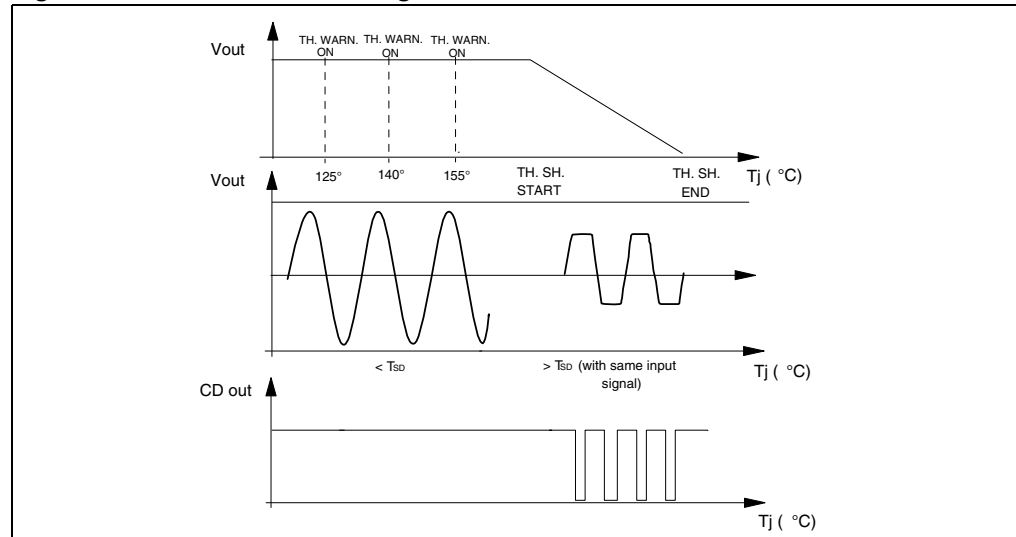
Thermal protection is implemented through thermal foldback (*Figure 29*).

Thermal foldback begins limiting the audio input to the amplifier stage as the junction temperatures rise above the normal operating range. This effectively limits the output power capability of the device thus reducing the temperature to acceptable levels without totally interrupting the operation of the device.

The output power will decrease to the point at which thermal equilibrium is reached. Thermal equilibrium will be reached when the reduction in output power reduces the dissipated power such that the die temperature falls below the thermal foldback threshold. Should the device cool, the audio level will increase until a new thermal equilibrium is reached or the amplifier reaches full power. Thermal foldback will reduce the audio output level in a linear manner.

Three thermal warning are available through the I<sup>2</sup>C bus data.

**Figure 29. Thermal foldback diagram**



### 6.1 I<sup>2</sup>C programming/reading sequences

A correct turn on/off sequence respectful of the diagnostic timings and producing no audible noises could be as follows (after battery connection):

Turn-on: (standby out + diag enable) --- 500 ms (min.) --- muting out

Turn-off: muting in --- 20 ms --- (diag disable + standby in)

Car radio Installation: diag enable (write) --- 200 ms --- I<sup>2</sup>C read (repeat until all faults disappear).

AC test: feed h.f. tone -- AC diag enable (write) --- wait > 3 cycles --- I<sup>2</sup>C read (repeat I<sup>2</sup>C reading until tweeter-off message disappears).

Offset test: device in play (no signal) -- offset enable - 30ms - I<sup>2</sup>C reading (repeat I<sup>2</sup>C reading until high-offset message disappears).

## 7 Fast muting

The muting time can be shortened to less than 1.5ms by setting (IB2) D5 = 1. This option can be useful in transient battery situations (i.e. during car engine cranking) to quickly turnoff the amplifier for avoiding any audible effects caused by noise/transients being injected by preamp stages. The bit must be set back to "0" shortly after the mute transition.

## 8 I<sup>2</sup>C bus interface

Data transmission from microprocessor to the TDA7564B and vice versa takes place through the 2 wires I<sup>2</sup>C bus interface, consisting of the two lines SDA and SCL (pull-up resistors to positive supply voltage must be connected).

### 8.1 Data validity

As shown by [Figure 30](#), the data on the SDA line must be stable during the high period of the clock. The high and low state of the data line can only change when the clock signal on the SCL line is LOW.

### 8.2 Start and stop conditions

As shown by [Figure 31](#) a start condition is a high to low transition of the SDA line while SCL is high. The stop condition is a low to high transition of the SDA line while SCL is high.

### 8.3 Byte format

Every byte transferred to the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

### 8.4 Acknowledge

The transmitter\* puts a resistive high level on the SDA line during the acknowledge clock pulse (see [Figure 32](#)). The receiver\*\* the acknowledges has to pull-down (low) the SDA line during the acknowledge clock pulse, so that the SDA line is stable low during this clock pulse.

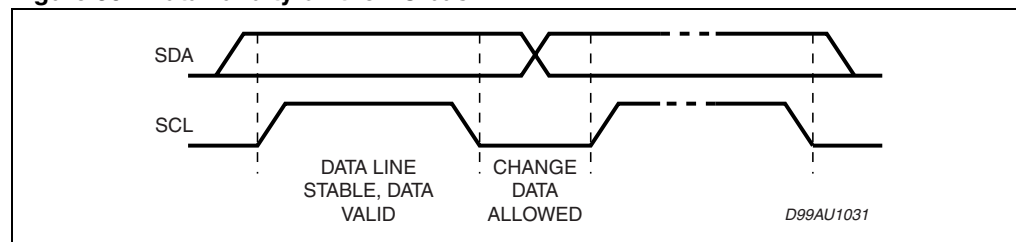
\* Transmitter

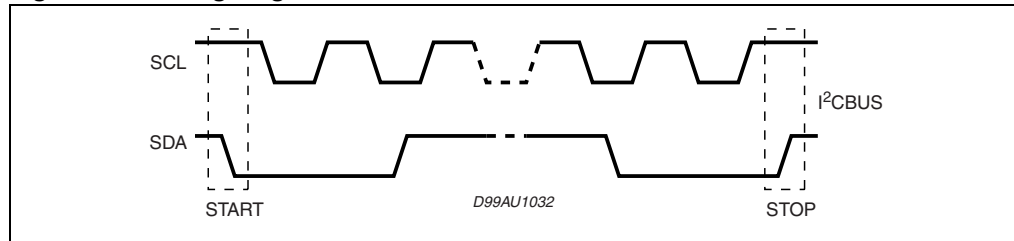
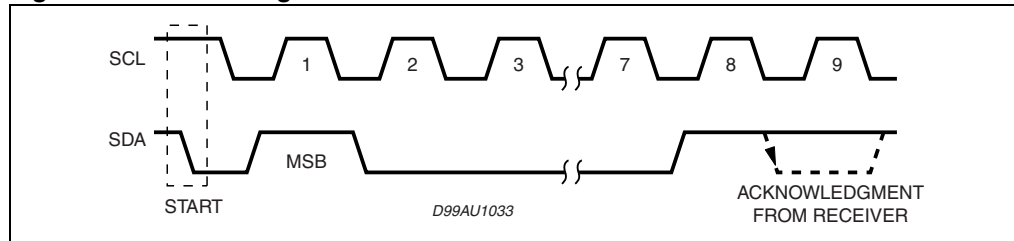
- master (μP) when it writes an address to the TDA7564B
- slave (TDA7564B) when the μP reads a data byte from TDA7564B

\*\* Receiver

- slave (TDA7564B) when the μP writes an address to the TDA7564B
- master (μP) when it reads a data byte from TDA7564B

**Figure 30. Data validity on the I<sup>2</sup>C bus**



**Figure 31. Timing diagram on the I<sup>2</sup>C bus****Figure 32. Acknowledge on the I<sup>2</sup>C bus**

## 9 Software specifications

All the functions of the TDA7564B are activated by I<sup>2</sup>C interface.

The bit 0 of the "Address byte" defines if the next bytes are write instruction (from  $\mu$ P to TDA7564B) or read instruction (from TDA7564B to  $\mu$ P).

D7						D0		
1	1	0	1	1	0	0	X	D8 Hex

X = 0 Write to device

X = 1 Read from device

If R/W = 0, the  $\mu$ P sends 2 "Instruction bytes": IB1 and IB2.

**Table 6. IB1**

Bit	Instruction decoding bit
D7	0
D6	Diagnostic enable (D6 = 1) Diagnostic defeat (D6 = 0)
D5	Offset Detection enable (D5 = 1) Offset Detection defeat (D5 = 0)
D4	Front Channel Gain = 26dB (D4 = 0) Gain = 12dB (D4 = 1)
D3	Rear Channel Gain = 26dB (D3 = 0) Gain = 12dB (D3 = 1)
D2	Mute front channels (D2 = 0) Unmute front channels (D2 = 1)
D1	Mute rear channels (D1 = 0) Unmute rear channels (D1 = 1)
D0	Clip detector 2% (D0 = 0) Clip detector 10% (D0 = 1)



**Table 7. IB2**

Bit	Instruction decoding bit
D7	Current detection threshold High th (D7 = 0) Low th (D7 = 1)
D6	0
D5	Normal muting time (D5 = 0) Fast muting time (D5 = 1)
D4	Standby on - Amplifier not working - (D4 = 0) Standby off - Amplifier working - (D4 = 1)
D3	Power amplifier mode diagnostic (D3 = 0) Line driver mode diagnostic (D3 = 1)
D2	Current detection diagnostic enabled (D2 = 1) Current detection diagnostic defeat (D2 = 0)
D1	Right Channels Power amplifier working in standard mode (D1 = 0) Power amplifier working in high efficiency mode (D1 = 1)
D0	Left Channels Power amplifier working in standard mode (D0 = 0) Power amplifier working in high efficiency mode (D0 = 1)

If R/W = 1, the TDA7564B sends 4 "Diagnostics Bytes" to  $\mu$ P: DB1, DB2, DB3 and DB4.

**Table 8. DB1**

Bit	Instruction decoding bit
D7	Thermal warning 1 active (D7 = 1) T=155 °C
D6	Diag. cycle not activated or not terminated (D6 = 0) Diag. cycle terminated (D6 = 1)
D5	Channel LF Current detection IB2 (D7) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)
D4	Channel LF Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1)
D3	Channel LF Normal load (D3 = 0) Short load (D3 = 1)
D2	Channel LF Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Offset diag.: No output offset (D2 = 0) Output offset detection (D2 = 1)
D1	Channel LF No short to Vcc (D1 = 0) Short to Vcc (D1 = 1)
D0	Channel LF No short to GND (D1 = 0) Short to GND (D1 = 1)

Table 9. DB2

Bit	Instruction decoding bit	
D7	Offset detection not activated (D7 = 0) Offset detection activated (D7 = 1)	
D6	Current sensor not activated (D6 = 0) Current sensor activated (D6 = 1)	
D5	Channel LR Current detection IB2 (D7) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)	Channel LR Current detection IB2 (D7) = 1 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)
D4	Channel LR Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1)	
D3	Channel LR Normal load (D3 = 0) Short load (D3 = 1)	
D2	Channel LR Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Permanent diag.: No output offset (D2 = 0) Output offset detection (D2 = 1)	
D1	Channel LR No short to Vcc (D1 = 0) Short to Vcc (D1 = 1)	
D0	Channel LR No short to GND (D1 = 0) Short to GND (D1 = 1)	

Table 10. DB3

Bit	Instruction decoding bit	
D7	Standby status (= IB2 - D4)	
D6	Diagnostic status (= IB1 - D6)	
D5	Channel RF Current detection IB2 (D7) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)	Channel RF Current detection IB2 (D7) = 1 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)
D4	Channel RF Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1)	
D3	Channel RF Normal load (D3 = 0) Short load (D3 = 1)	
D2	Channel RF Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Permanent diag.: No output offset (D2 = 0) Output offset detection (D2 = 1)	
D1	Channel RF No short to Vcc (D1 = 0) Short to Vcc (D1 = 1)	
D0	Channel RF No short to GND (D1 = 0) Short to GND (D1 = 1)	

Table 11. DB4

Bit	Instruction decoding bit	
D7	Thermal warning 2 active (D7 =1) T=140°C	
D6	Thermal warning 3 active (D6 =1) T=125°C	
D5	Channel RR Current detection IB2 (D7) = 0 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)	Channel RR Current detection IB2 (D7) = 1 Output peak current < 250 mA - Open load (D5 = 1) Output peak current > 500 mA - Normal load (D5 = 0)
D4	Channel RR Turn-on diagnostic (D4 = 0) Permanent diagnostic (D4 = 1)	
D3	Channel RR Normal load (D3 = 0) Short load (D3 = 1)	
D2	Channel RR Turn-on diag.: No open load (D2 = 0) Open load detection (D2 = 1) Permanent diag.: No output offset (D2 = 0) Output offset detection (D2 = 1)	
D1	Channel RR No short to Vcc (D1 = 0) Short to Vcc (D1 = 1)	
D0	Channel RR No short to GND (D1 = 0) Short to GND (D1 = 1)	

## 10 Examples of bytes sequence

### 1 - Turn-on diagnostic - Write operation

Start	Address byte with D0 = 0	ACK	IB1 with D6 = 1	ACK	IB2	ACK	STOP
-------	--------------------------	-----	-----------------	-----	-----	-----	------

### 2 - Turn-on diagnostic - Read operation

Start	Address byte with D0 = 1	ACK	DB1	ACK	DB2	ACK	DB3	ACK	DB4	ACK	STOP
-------	--------------------------	-----	-----	-----	-----	-----	-----	-----	-----	-----	------

The delay from 1 to 2 can be selected by software, starting from 1 ms

**3a** - Turn-on of the power amplifier with 26dB gain, mute on, diagnostic defeat, High eff. mode both channels.

Start	Address byte with D0 = 0	ACK	IB1	ACK	IB2	ACK	STOP
			X000000X		XXX1X011		

### 3b - Turn-off of the power amplifier

Start	Address byte with D0 = 0	ACK	IB1	ACK	IB2	ACK	STOP
			X0XXXXXX		XXX0XXXX		

### 4 - Offset detection procedure enable

Start	Address byte with D0 = 0	ACK	IB1	ACK	IB2	ACK	STOP
			XX1XX11X		XXX1X0XX		

**5** - Offset detection procedure stop and reading operation (the results are valid only for the offset detection bits (D2 of the bytes DB1, DB2, DB3, DB4)

Start	Address byte with D0 = 1	ACK	DB1	ACK	DB2	ACK	DB3	ACK	DB4	ACK	STOP
-------	--------------------------	-----	-----	-----	-----	-----	-----	-----	-----	-----	------

- The purpose of this test is to check if a D.C. offset (2V typ.) is present on the outputs, produced by input capacitor with anomalous leakage current or humidity between pins.
- The delay from 4 to 5 can be selected by software, starting from 1ms

**6** - Current detection procedure start (the AC inputs must be with a proper signal that depends on the type of load)

Start	Address byte with D0 = 0	ACK	IB1	ACK	IB2	ACK	STOP
			XX01111X		XXX1X1XX		

Current detection reading operation (the results valid only for the current sensor detection bits - D5 of the bytes DB1, DB2, DB3, DB4)

Start	Address byte with D0 = 1	ACK	DB1	ACK	DB2	ACK	DB3	ACK	DB4	ACK	STOP
-------	--------------------------	-----	-----	-----	-----	-----	-----	-----	-----	-----	------

- During the test, a sinus wave with a proper amplitude and frequency (depending on the loudspeaker under test) must be present. The minimum number of periods that are needed to detect a normal load is 5.
- The delay from 6 to 7 can be selected by software, starting from 1ms.

# 11 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com).

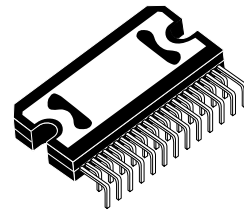
ECOPACK® is an ST trademark.

**Figure 33. Flexiwatt25 (horizontal) mechanical data and package dimensions**

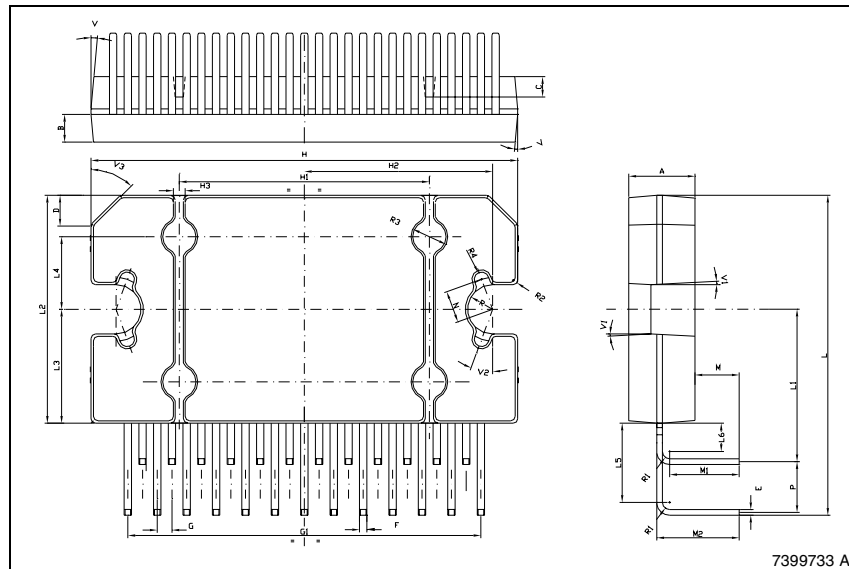
DIM.	mm			Inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.45	4.50	4.65	0.175	0.177	0.183
B	1.80	1.90	2.00	0.070	0.074	0.079
C		1.40			0.055	
D		2.00			0.079	
E	0.37	0.39	0.42	0.014	0.015	0.016
F (1)			0.57			0.022
G	0.75	1.00	1.25	0.029	0.040	0.049
G1	23.70	24.00	24.30	0.933	0.945	0.957
H (2)	28.90	29.23	29.30	1.139	1.150	1.153
H1		17.00			0.669	
H2		12.80			0.503	
H3		0.80			0.031	
L (2)	21.64	22.04	22.44	0.852	0.868	0.883
L1	10.15	10.5	10.85	0.40	0.413	0.427
L2 (2)	15.50	15.70	15.90	0.610	0.618	0.626
L3	7.70	7.85	7.95	0.303	0.309	0.313
L4		5			0.197	
L5	5.15	5.45	5.85	0.203	0.214	0.23
L6	1.80	1.95	2.10	0.070	0.077	0.083
M	2.75	3.00	3.50	0.108	0.118	0.138
M1		4.73			0.186	
M2		5.61			0.220	
N		2.20			0.086	
P	3.20	3.50	3.80	0.126	0.138	0.15
R		1.70			0.067	
R1		0.50			0.02	
R2		0.30			0.12	
R3		1.25			0.049	
R4		0.50			0.02	
V	5° (typ.)					
V1	3° (typ.)					
V2	20° (typ.)					
V3	45° (typ.)					

(1): dam-bar protusion not included; (2): molding protusion included

## OUTLINE AND MECHANICAL DATA



## Flexiwatt25 (Horizontal)



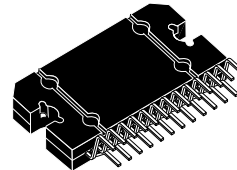
7399733 A

Figure 34. Flexiwatt25 (vertical) mechanical data and package dimensions

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.45	4.50	4.65	0.175	0.177	0.183
B	1.80	1.90	2.00	0.070	0.074	0.079
C		1.40			0.055	
D	0.75	0.90	1.05	0.029	0.035	0.041
E	0.37	0.39	0.42	0.014	0.015	0.016
F (1)			0.57			0.022
G	0.80	1.00	1.20	0.031	0.040	0.047
G1	23.75	24.00	24.25	0.935	0.945	0.955
H (2)	28.90	29.23	29.30	1.139	1.150	1.153
H1		17.00			0.669	
H2		12.80			0.503	
H3		0.80			0.031	
L (2)	22.07	22.47	22.87	0.869	0.884	0.904
L1	18.57	18.97	19.37	0.731	0.747	0.762
L2 (2)	15.50	15.70	15.90	0.610	0.618	0.626
L3	7.70	7.85	7.95	0.303	0.309	0.313
L4		5			0.197	
L5		3.5			0.138	
M	3.70	4.00	4.30	0.145	0.157	0.169
M1	3.60	4.00	4.40	0.142	0.157	0.173
N		2.20			0.086	
O		2			0.079	
R		1.70			0.067	
R1		0.5			0.02	
R2		0.3			0.12	
R3		1.25			0.049	
R4		0.50			0.019	
V			5° (T.p.)			
V1			3° (Typ.)			
V2			20° (Typ.)			
V3			45° (Typ.)			

(1): dam-bar protusion not included  
(2): molding protusion included

### OUTLINE AND MECHANICAL DATA



### Flexiwatt25 (vertical)

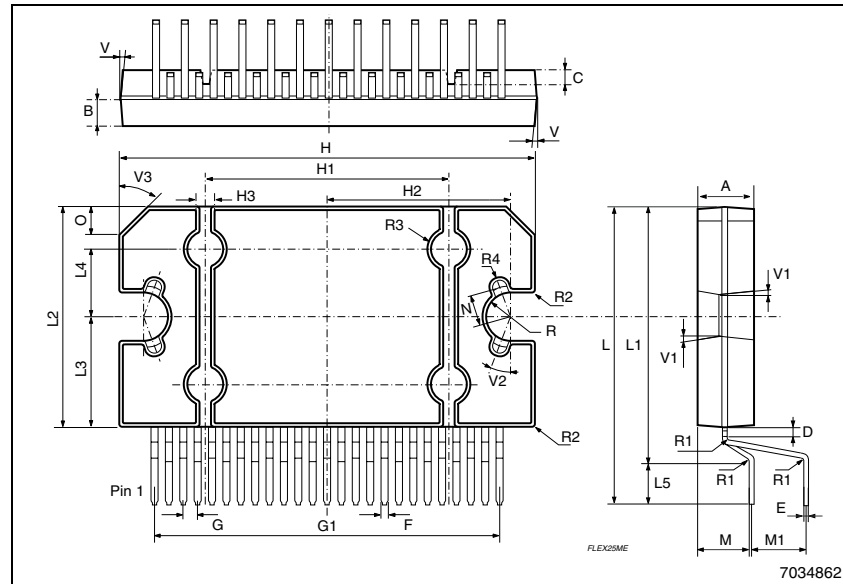
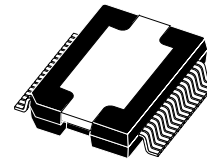


Figure 35. PowerSO36 (slug up) mechanical data and package dimensions

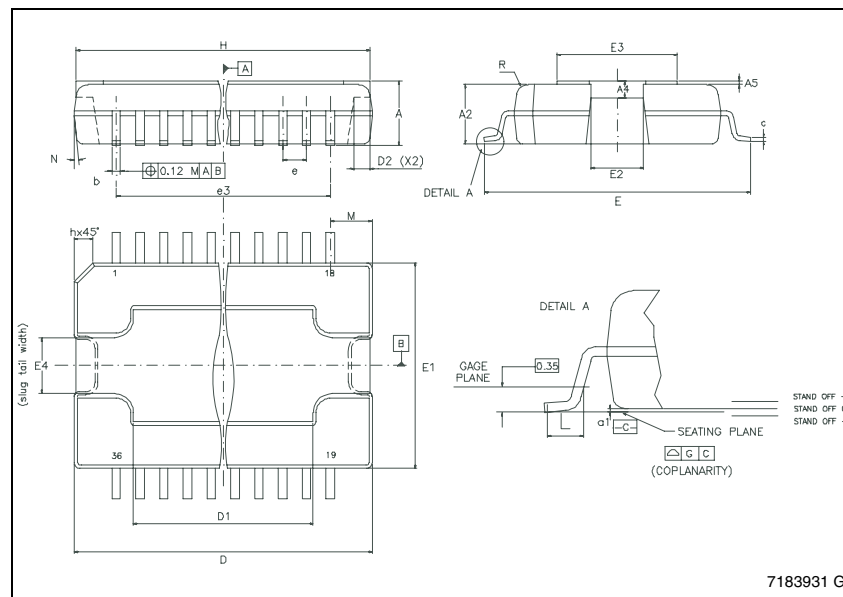
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	3.270	-	3.410	0.1287	-	0.1343
A2	3.100	-	3.180	0.1220	-	0.1252
A4	0.800	-	1.000	0.0315	-	0.0394
A5	-	0.200	-	-	0.0079	-
a1	0.030	-	-0.040	0.0012	-	-0.0016
b	0.220	-	0.380	0.0087	-	0.0150
c	0.230	-	0.320	0.0091	-	0.0126
D	15.800	-	16.000	0.6220	-	0.6299
D1	9.400	-	9.800	0.3701	-	0.3858
D2	-	1.000	-	-	0.0394	-
E	13.900	-	14.500	0.5472	-	0.5709
E1	10.900	-	11.100	0.4291	-	0.4370
E2	-	-	2.900	-	-	0.1142
E3	5.800	-	6.200	0.2283	-	0.2441
E4	2.900	-	3.200	0.1142	-	0.1260
e	-	0.650	-	-	0.0256	-
e3	-	11.050	-	-	0.4350	-
G	0	-	0.075	0	-	0.0031
H	15.500	-	15.900	0.6102	-	0.6260
h	-	-	1.100	-	-	0.0433
L	0.800	-	1.100	0.0315	-	0.0433
N	-	-	10°	-	-	10°
s	-	-	8°	-	-	8°

- (1) "D and E1" do not include mold flash or protrusions.  
Mold flash or protrusions shall not exceed 0.15mm (0.006").  
(2) No intrusion allowed inwards the leads.

### OUTLINE AND MECHANICAL DATA



### PowerSO36 (SLUG UP)





## 12 Revision history

**Table 12. Document revision history**

Date	Revision	Changes
14-Sep-2006	1	Initial release.
22-Jan-2007	2	Add new package and part numbers in <a href="#">Table 1: Device summary on page 1</a> . Add PowerSO36 pin connections diagram <a href="#">Figure 4 on page 7</a> . Changed the max. value of the “Lonp” parameter in <a href="#">Table 4 on page 8</a> . Modified <a href="#">Figure 23 on page 15</a> . Add PowerSO36 package information <a href="#">Figure 35 on page 32</a> . Changed the min. and typ. value of the $V_M$ parameter in the <a href="#">Table 4</a> . Updated <a href="#">Table 3: Thermal data</a> .
15-Dec-2009	3	Updated <a href="#">Figure 35: PowerSO36 (slug up) mechanical data and package dimensions on page 32</a> .

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